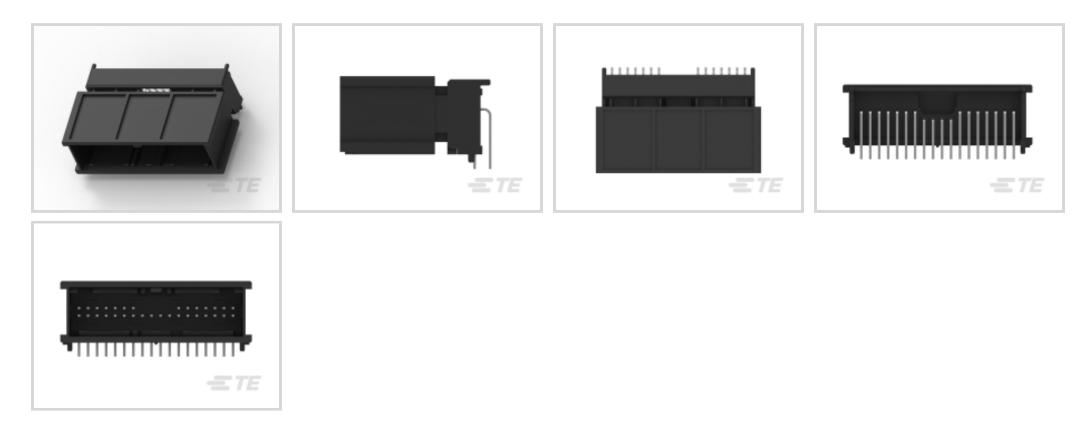
2177419-3 - ACTIVE

Nano MQS

TE Internal #: 2177419-3 PCB Mount Header, Horizontal, Wire-to-Board, 32 Position, .071 in [1.8 mm] Centerline, Fully Shrouded, Tin (Sn), Through Hole -Solder, Nano MQS

View on TE.com >

Connectors > PCB Connectors > PCB Headers & Receptacles > MINIATURIZED HEADER



Connector System: Wire-to-Board Number of Positions: 32 Centerline (Pitch): 1.8 mm [.071 in] Sealable: No

PCB Mount Orientation: Horizontal

All MINIATURIZED HEADER (45)



Features

Product Type Features

Hybrid Header	No
Connector & Housing Shape	Rectangular
PCB Connector Assembly Type	PCB Mount Header
Header Type	Fully Shrouded
Connector System	Wire-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Number of Sections	1
Number of Signal Positions	32
Number of Positions	32
PCB Mount Orientation	Horizontal
Number of Rows	2

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PCB Mount Header, Horizontal, Wire-to-Board, 32 Position, .071 in [1.8 mm] Centerline, Fully Shrouded, Tin (Sn), Through Hole - Solder, Nano MQS



Electrical Characteristics	
Nominal Voltage Architecture	12 V
Operating Voltage	12 VDC
Body Features	
Primary Product Color	Black
Connector Code	A
Contact Features	
Contact Size	.5mm
Contact Type	Tab
Mating Tab Width	.5 mm[.02 in]
Mating Tab Thickness	.4 mm[.016 in]
Contact Mating Area Plating Material	Tin (Sn)
Termination Features	
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mounting Holes	Without
Mating Retention	With
Mating Alignment	With
PCB Mount Alignment	With
Panel Mount Feature	Without
PCB Mount Retention	Without
Mating Retention Type	Locking Interface
Housing Features	
Centerline (Pitch)	1.8 mm[.071 in]
Dimensions	
Connector Length	38.05 mm[1.498 in]
Connector Width	24.47 mm[.963 in]
PCB Thickness (Recommended)	.8 mm[.031 in]
Profile Height from PCB	12.6 mm[.496 in]
Usage Conditions	
Operating Temperature (Max)	65 °C, 70 °C, 75 °C, 80 °C, 85 °C, 90 °C, 100 °C, 105 °C[149 °F][158 °F][167 °F][176 °F]
	07/23/2022 08

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	[185 °F][194 °F][212 °F][221 °F][230 °F][248 ° F]
Operating Temperature Range	-40 - 105 °C[-40 - 221 °F]
Operation/Application	
Shielded	No
Circuit Application	Signal
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Type	Tray
Packaging Quantity	46
Other	
Interface Number	114-20160

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2022 (224) Candidate List Declared Against: JAN 2022 (223) SVHC > Threshold: Not Yet Reviewed
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides

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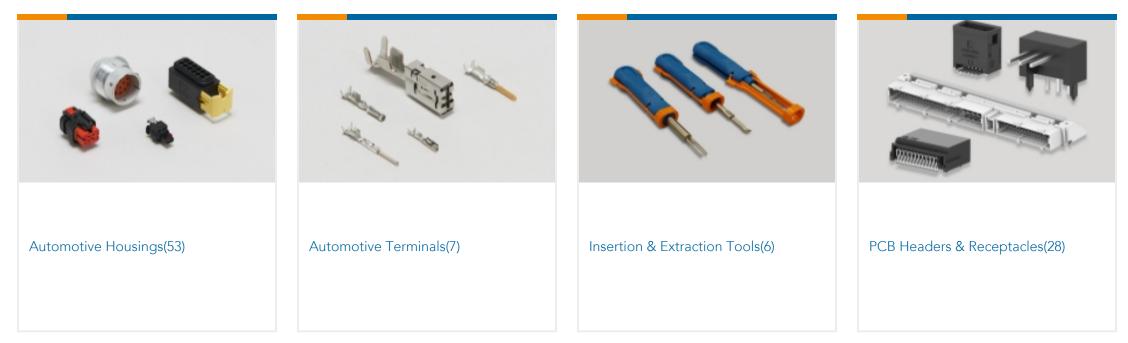


on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts



Also in the Series | Nano MQS



Customers Also Bought





Documents

Product Drawings

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PCB Mount Header, Horizontal, Wire-to-Board, 32 Position, .071 in [1.8 mm] Centerline, Fully Shrouded, Tin (Sn), Through Hole - Solder, Nano MQS



32POS, TAB 0.5X0.4, HEADER ASSY, CODA

English

CAD Files

3D PDF 3D

Customer View Model

ENG_CVM_CVM_2177419-3_D.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2177419-3_D.3d_igs.zip

English

Customer View Model ENG_CVM_CVM_2177419-3_D.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Application Specification

English